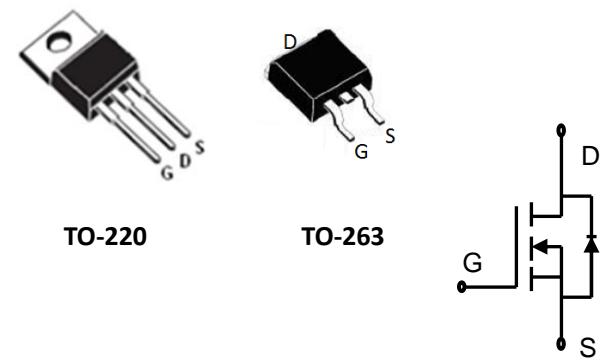


Lonten N-channel 80V, 60A, 16mΩ Power MOSFET

<p>Description</p> <p>These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.</p> <p>Features</p> <ul style="list-style-type: none"> ◆ 80V, 60A, $R_{DS(on),max} = 16\text{m}\Omega$ @ $V_{GS} = 10\text{V}$ ◆ Improved dv/dt capability ◆ Fast switching ◆ 100% EAS Guaranteed ◆ Green device available <p>Applications</p> <ul style="list-style-type: none"> ◆ Motor Drives ◆ UPS ◆ DC-DC Converter 	<p>Product Summary</p> <table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%;">V_{DSS}</td><td style="width: 50%;">80V</td></tr> <tr> <td>R_{DS(on),max} @ V_{GS} = 10V</td><td>16mΩ</td></tr> <tr> <td>I_D</td><td>60A</td></tr> </table> <p>Pin Configuration</p>  <p>TO-220 TO-263</p> <p>N-Channel MOSFET</p> <p></p>	V _{DSS}	80V	R _{DS(on),max} @ V _{GS} = 10V	16mΩ	I _D	60A
V _{DSS}	80V						
R _{DS(on),max} @ V _{GS} = 10V	16mΩ						
I _D	60A						

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	80	V
Continuous drain current (T _C = 25°C)	I _D	60	A
Continuous drain current (T _C = 100°C)		39	A
Pulsed drain current ¹⁾	I _{DM}	240	A
Gate-Source voltage	V _{GSS}	±20	V
Avalanche energy ²⁾	E _{AS}	132	mJ
Power Dissipation (T _C = 25°C)	P _D	110	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	T _J	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{θJC}	0.88	°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62	°C/W

Package Marking and Ordering Information

Device	Device Package	Marking
LNC08R160	TO-220	LNC08R160
LNE08R160	TO-263	LNE08R160

Electrical Characteristics

T_J = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250μA	80	---	---	V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0	1.6	2.5	V
Drain-source leakage current	I _{DSS}	V _{DS} =80V, V _{GS} =0V, T _J = 25°C	---	---	1	μA
		V _{DS} =64V, V _{GS} =0V, T _J = 125°C	---	---	30	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V	---	---	100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V	---	---	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D = 30 A	---	12.5	16	mΩ
		V _{GS} =4.5 V, I _D =20 A	---	16.5	21	mΩ
Forward transconductance	g _f	V _{DS} =10V , I _D =30A	---	52	---	S
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, F = 1MHz	---	3116	---	pF
Output capacitance	C _{oss}		---	196	---	
Reverse transfer capacitance	C _{rss}		---	140	---	
Turn-on delay time	t _{d(on)}	V _{DD} =40V,V _{GS} =10V, I _D = 30A	---	10.7	---	ns
Rise time	t _r		---	17.7	---	
Turn-off delay time	t _{d(off)}		---	139.7	---	
Fall time	t _f		---	28.3	---	
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	1.5	---	Ω
Gate charge characteristics						
Gate to source charge	Q _{gs}	V _{DS} =40 V, I _D =30A, V _{GS} = 10 V	---	13.6	---	nC
Gate to drain charge	Q _{gd}		---	11.7	---	
Gate charge tota	Q _g		---	58	---	
Drain-Source diode characteristics and Maximum Ratings						
Diode Forward Voltage ³⁾	V _{SD}	V _{GS} =0V, I _S =30A, T _J =25°C	---	0.85	1.3	V
Reverse Recovery Time	t _{rr}	I _S =30A, di/dt=100A/us, T _J =25°C	---	27.7	---	ns
Reverse Recovery Charge	Q _{rr}		---	41	---	nC

Notes:

1: Repetitive Rating: Pulse width limited by maximum junction temperature.

2: V_{DD}=50V, V_{GS}=10V, L=0.5mH, I_{AS}=23A, R_G=25Ω, Starting T_J=25°C.

3: Pulse Test: Pulse Width ≤300 μ s, Duty Cycle≤2%.

Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

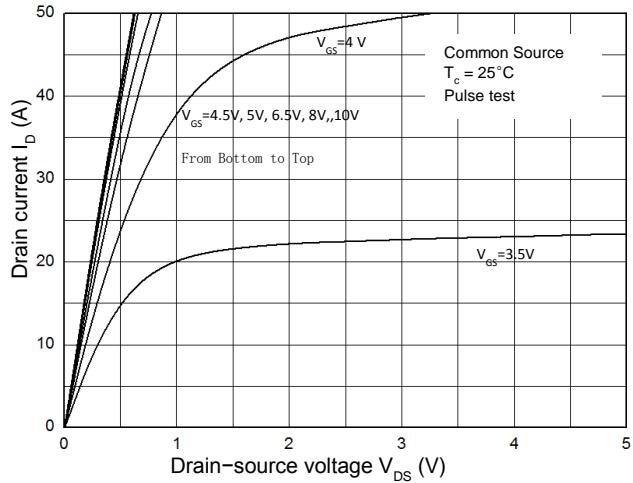


Figure 2. Transfer Characteristics

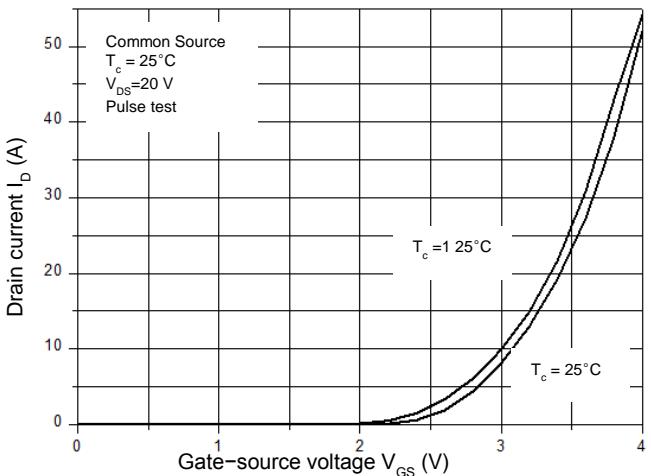


Figure 3. Capacitance Characteristics

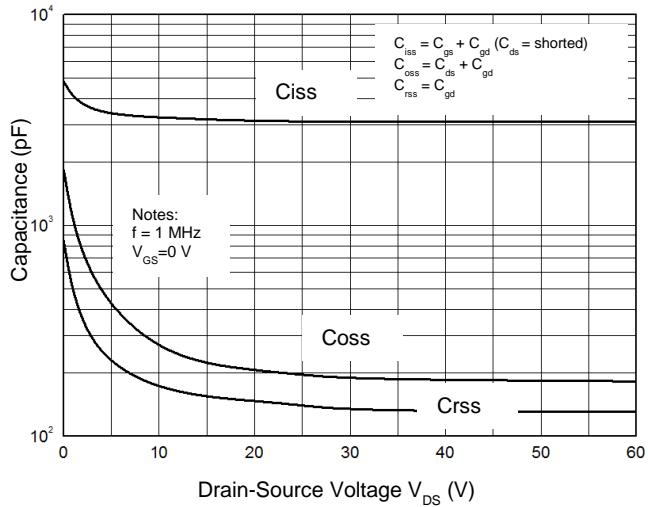


Figure 4. Gate Charge Waveform

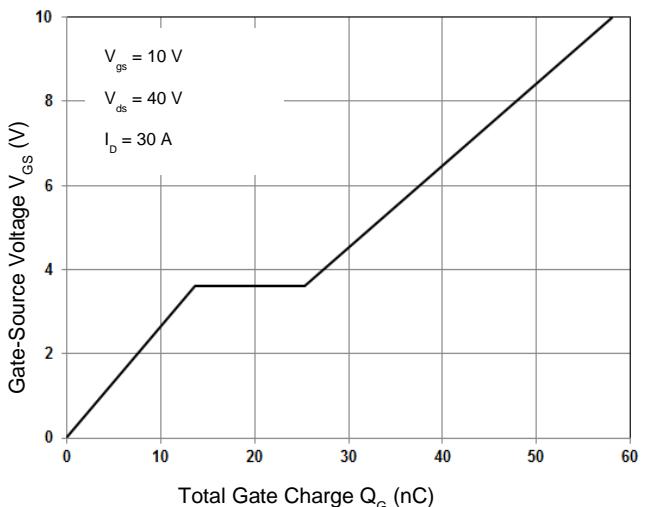


Figure 5. Body-Diode Characteristics

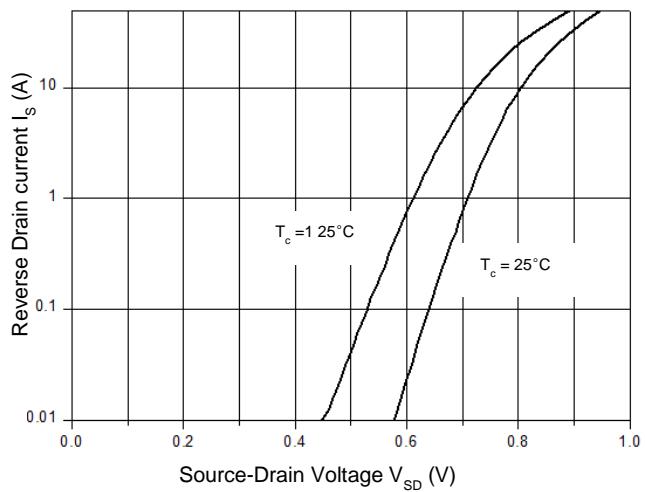


Figure 6. Rdson-Drain Current

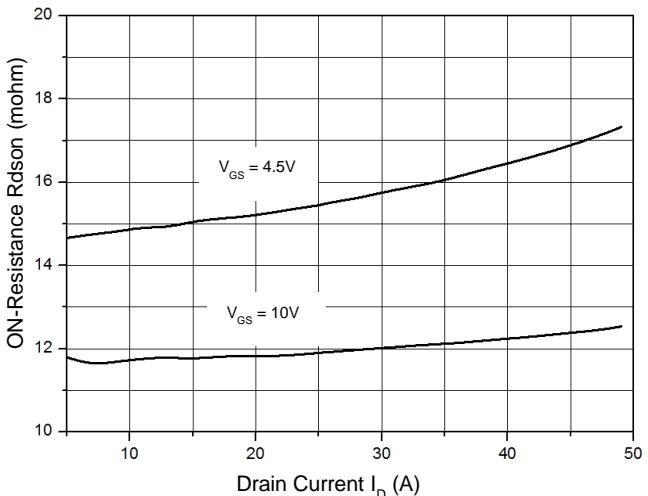


Figure 7. Rdson-Junction Temperature(°C)

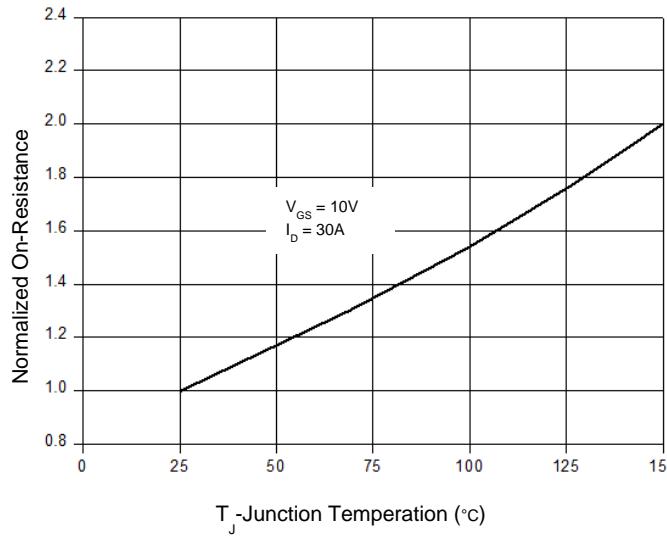


Figure 8. Maximum Safe Operating Area

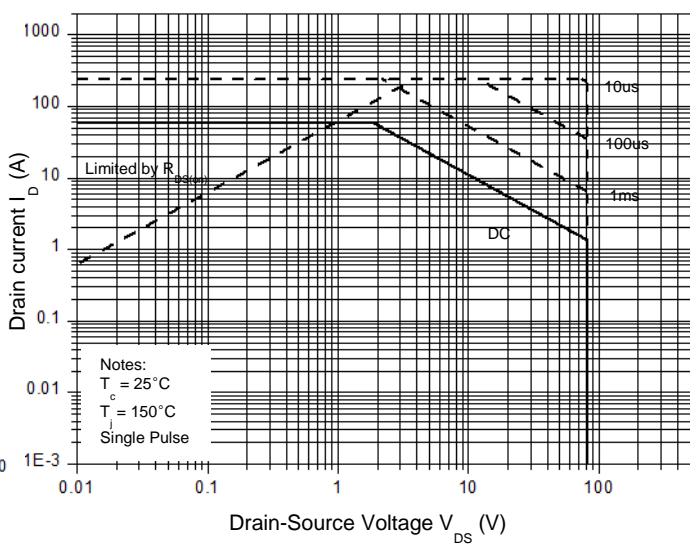


Figure 6. Normalized Maximum Transient Thermal Impedance (RthJC)

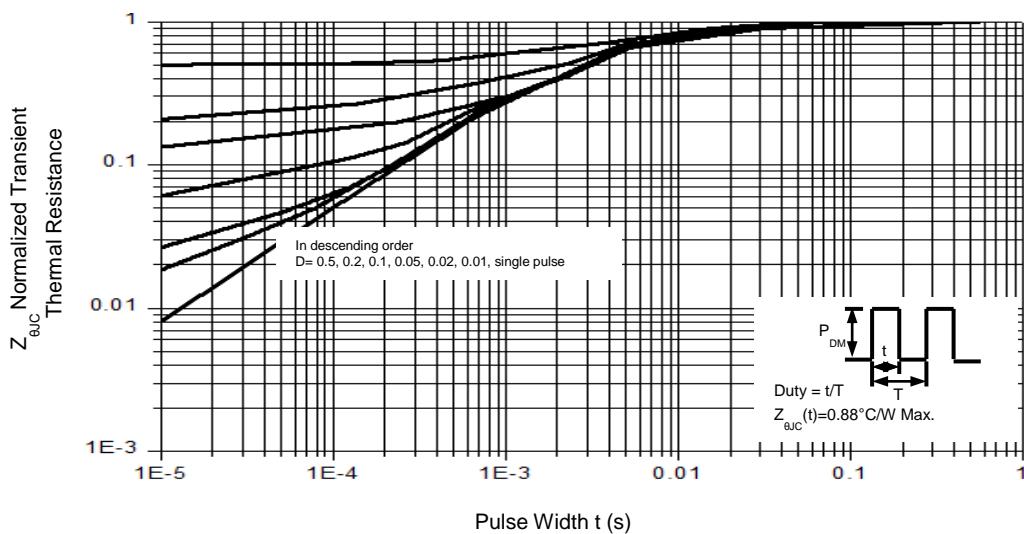
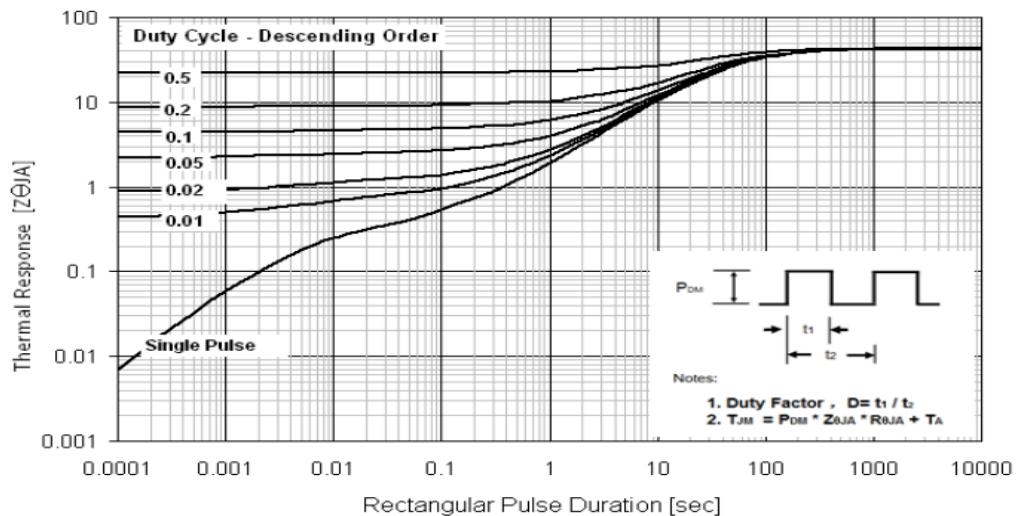


Figure 7. Normalized Maximum Transient Thermal Impedance (RthJA)



Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform

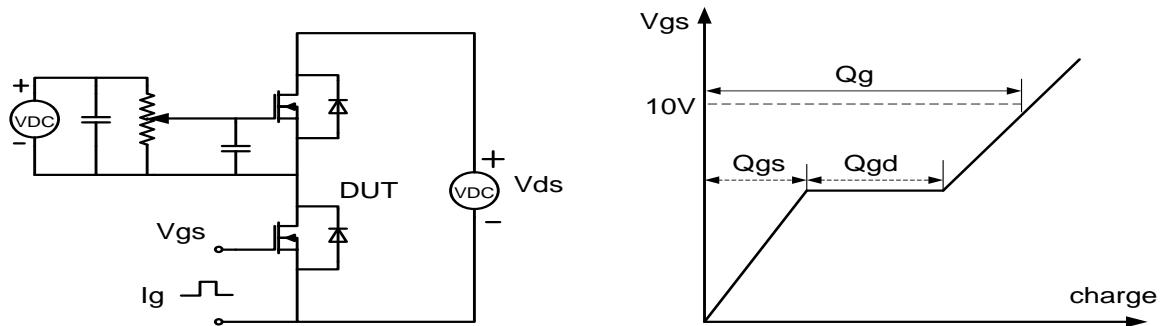


Figure 9. Resistive Switching Test Circuit & Waveforms

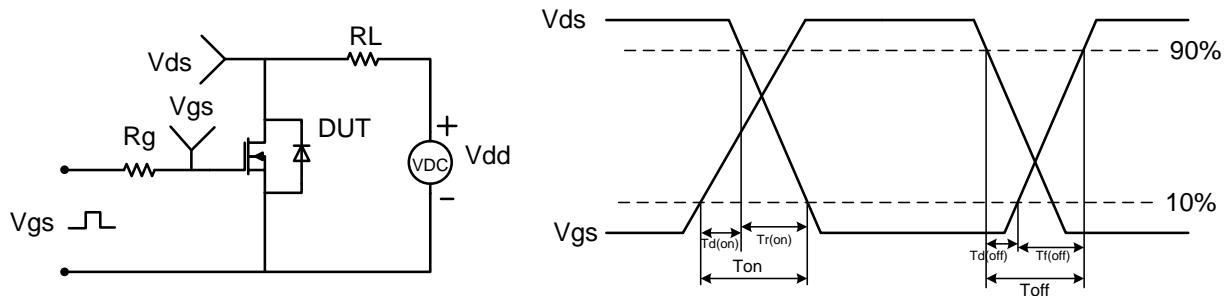


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

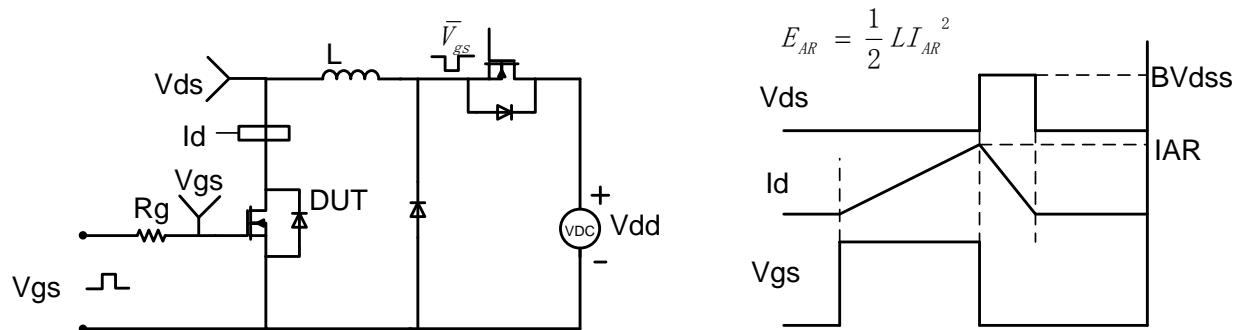
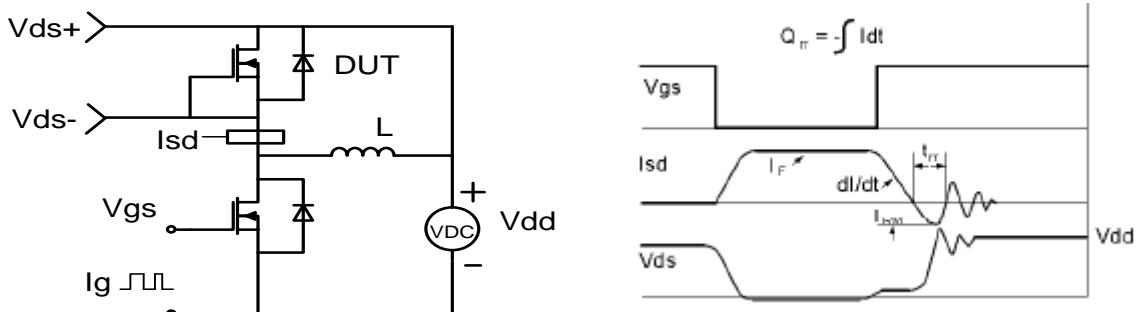
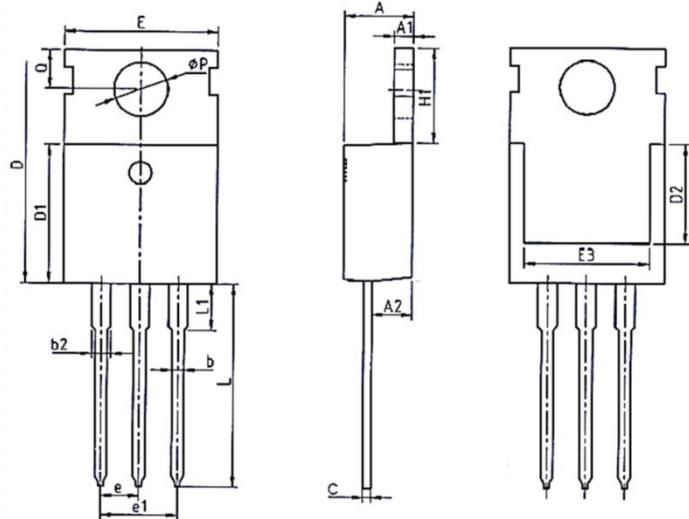


Figure 11. Diode Recovery Circuit & Waveform

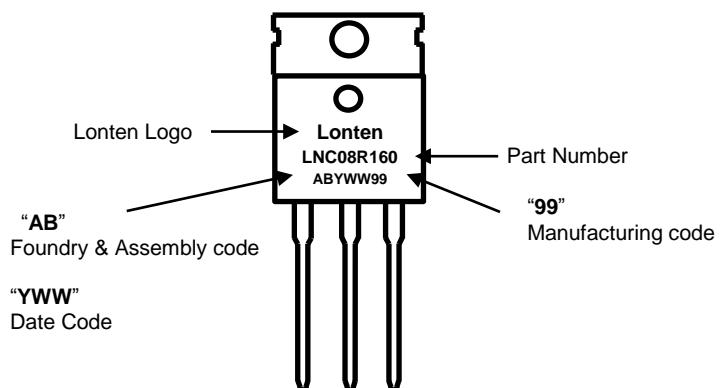


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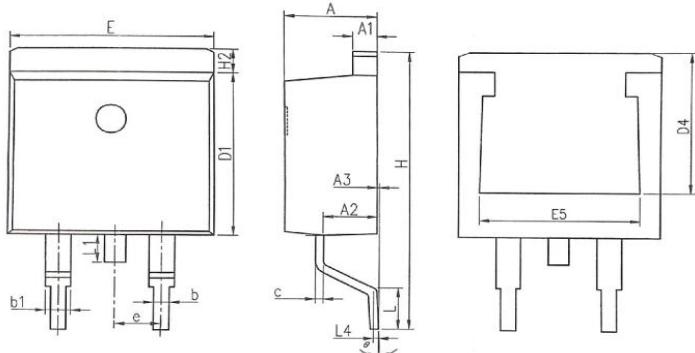


SYMBOL	COMMON DIMENSIONS			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	4.37	4.57	4.70	0.172	0.180	0.185
A1	1.25	1.30	1.40	0.049	0.051	0.055
A2	2.20	2.40	2.60	0.087	0.094	0.102
b	0.70	0.80	0.95	0.028	0.031	0.037
b2	1.17	1.27	1.47	0.046	0.050	0.058
c	0.45	0.50	0.60	0.018	0.020	0.024
D	15.10	15.60	16.10	0.594	0.614	0.634
D1	8.80	9.10	9.40	0.346	0.358	0.370
D2	5.50	-	-	0.217	-	-
E	9.70	10.00	10.30	0.382	0.394	0.406
E3	7.00	-	-	0.276	-	-
e	2.54BCS			0.1BSC		
e1	5.08BCS			0.2REF		
H1	6.25	6.50	6.85	0.246	0.256	0.270
L	12.75	13.50	13.80	0.502	0.531	0.543
L1	-	3.10	3.40	-	0.122	0.134
ØP	3.40	3.60	3.80	0.134	0.142	0.150
Q	2.60	2.80	3.00	0.102	0.110	0.118

TO-220 Part Marking Information

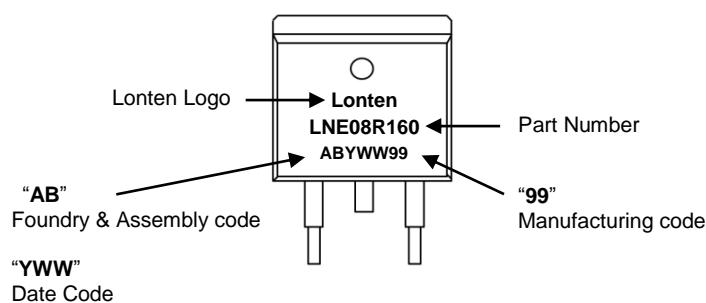


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SYMBOL	COMMON DIMENSIONS							
	MM	MIN	NOM	MAX	INCH	MIN	NOM	MAX
A	4.37	4.57	4.77	0.172	0.180	0.188		
A1	1.22	1.27	1.42	0.048	0.050	0.056		
A2	2.49	2.69	2.89	0.098	0.106	0.114		
A3	0.00	0.13	0.25	0.000	0.005	0.010		
b	0.70	0.81	0.96	0.028	0.032	0.038		
b1	1.17	1.27	1.47	0.046	0.050	0.058		
c	0.30	0.38	0.53	0.012	0.015	0.021		
D1	8.50	8.70	8.90	0.335	0.343	0.350		
D4	6.60	—	—	0.260	—	—		
E	9.86	10.16	10.36	0.388	0.400	0.408		
E5	7.06	—	—	0.278	—	—		
e	2.54 BSC			0.100 BSC				
H	14.70	15.10	15.50	0.579	0.594	0.610		
H2	1.07	1.27	1.47	0.042	0.050	0.058		
L	2.00	2.30	2.60	0.079	0.091	0.102		
L1	1.40	1.55	1.70	0.055	0.061	0.067		
L4	0.25 BSC			0.010 BSC				
θ	0°	5°	9°	0°	5°	9°		

TO-263 Part Marking Information



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